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CWA005

DC-DC Power Supply

(Document Rev A02, 6/17/24)

28VDC Input Multiple Output, 311W Max Total

Market: Military Application: VME power for Electronic Warfare

Features

- 28VDC +/- .75V
- Designed to meet portions of Mil-Std-810F environmental specs.*
- Designed to meet portions of Mil-Std-461 for surface ship applications.*
- VME Power.

* Contact AEGIS Power Systems for specific details.

Product Highlights

This chassis mount open frame filtered dc-dc power converter has multiple outputs available with N+1 redundancy. This COTS solution works well for Mil-cots and is designed to meet portions MIL-STD-810F vibration and shock, and MIL-STD-461surface ship applications EMI requirements. When compared to VME power supplies using conventional technology, this chassis mount forced air cooled ac-dc power supply converter provides users with higher efficiency (81%), lower weight (6.3 lbs), and higher power (up to 311W, N+1 redundant).

<u>AEGIS Power Systems, Inc.</u> specializes in the front end design, development, and manufacture of Rapid Response Custom Switching Power Supplies for defense, industry, telecomm, aircraft, shipboard, rack mount, electric powered vehicle, and Mil-Cots military power supply applications. Contact Aegis for specific details on what can be designed for your particular military power supply application and what portions of a particular military standard can be offered for that power supply.

Table 1: Maximum Ratings

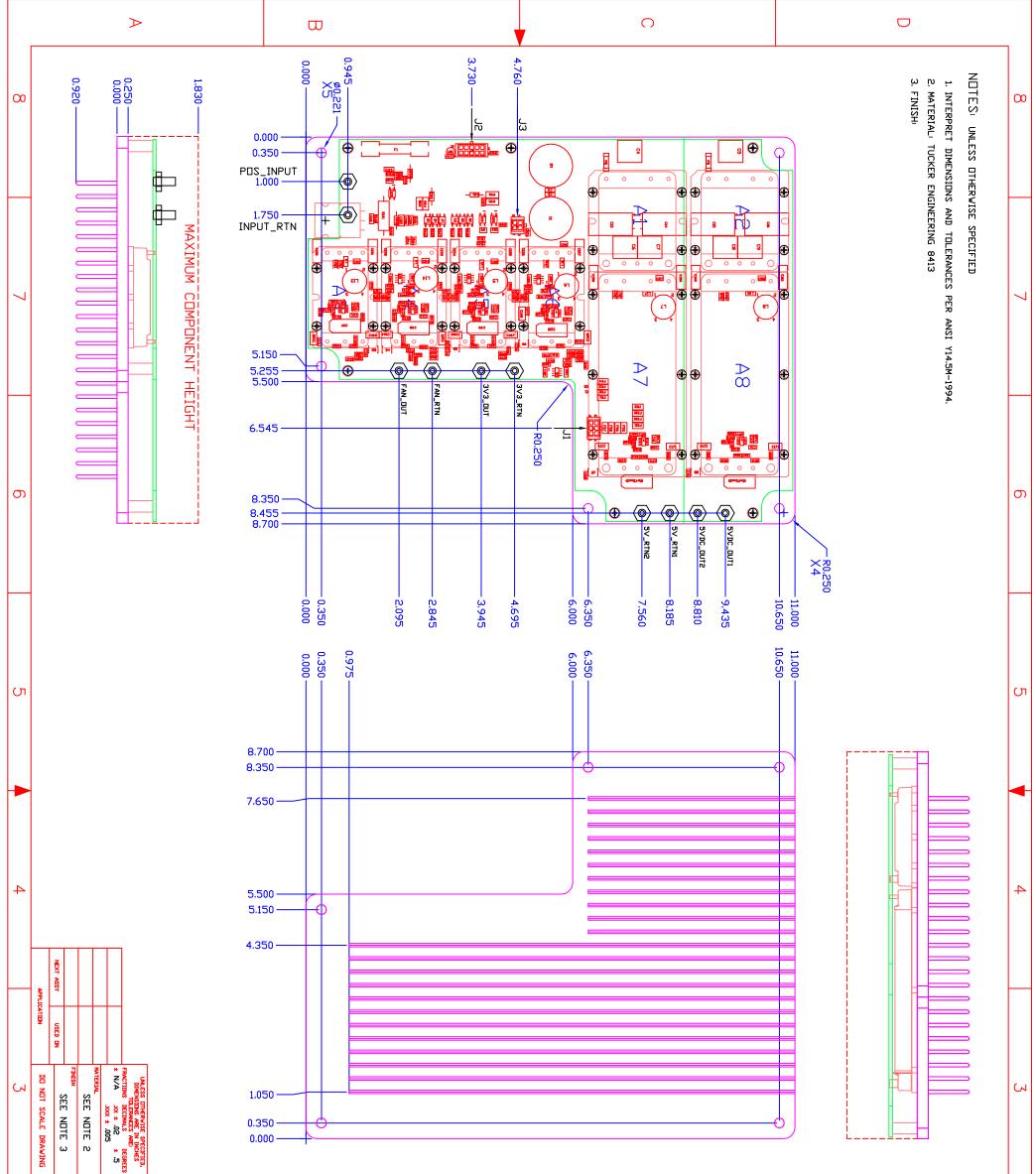
Parameter	Rating	Unit	Notes
Vin max range	27.25 to 28.75	VDC	
Temperature range	0 to +65	°C	
Output power	311	W	
+3.3Vdc output	13.2	W	On when enabled
+5Vdc output	216.5	W	On when enabled
+12Vdc output	82	W	On when power applied

Input voltage:28VDC +/- 0.75VDC.Input current:13.7A @ 28VDC, typical.Input power:384W @ 28VDC, typical.Output power:311W Maximum. (N+1 redundant)Output voltages:See table 2 for details.Efficiency:81% Typical, 78% Minimum.Output ripple:See table 2 for details.Current Limit:Short circuit protected with automatic recovery.Start up time:1 Sec. Maximum.Voltage set point:± 2.5%.Line regulation:± 2.5%.Temperature:0°C to +50°C Operating40°C to +70°C Non-Operating.Pocoling:Nextmant for cooling across internal Heatsink.Package:Chassis mounted open frame.Dimensions:1.83 "H x 8.7"W x 11" L (see mechanical drawing).Vibration:(see mechanical drawing).Vibration:Oesigned to meet MIL-STD-810F, Method 514.5, Procedure I.Fine:Designed to meet MIL-STD-461E (CE101, CE102 and CS101).	SPECIFICATIONS	(Typical at 25°C, nominal line and 100% load, unless otherwise specified.)
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Specifications subject to change without notice.

Table 2: Voltage Outputs

CWA005	V1	V2	V3						
Voltage	+5Vdc	+3.3Vdc	+12Vdc						
Current	43.3A	4A	6.83A						
Power	82W								
Ripple	50mVpk-pk	50mVpk-pk	100mVpk-pk						
Maximum total output power is 311W (all DC outputs combined).									



2	INTER STATE FROM NO INFER	MVM 12/13/10 C W		AEGIS POWER SYSTEMS, INC. PR REPRODUCTION, OR USE OF ANY EXPRESS WRITTEN PERMISSION	V24A5H3UU: 84.47.	A4 V24C3V3H75i 79% EF A5 V24C12H100: 88.0% EF A6 V24C12H100: 88.0% EF A7 V24A5H300: 84.4% EF	MFIAM9: 97% EFF. : MFIAM9: 97% EFF. : VF1AM9: 97% EFF. :	NDTE: INPUT AND DUTPUT	PIN 1 - ATP TEST CONNECTOR PIN 2 - ATP TEST CONNECTOR PIN 3 - ATP TEST CONNECTOR PIN 4 - ATP TEST CONNECTOR	J3: MOLEX MICRO FIT 43045 MATES WITH 43025-0400	PIN 6 - INPUT VOLTAGE STATUS LED - PIN 7 - DC ENABLE FOR SWITCHED SUF PIN 8 - N+1 MODULE STATUS COLLECTO PIN 9 - OPEN PIN 10 - ANALOG TEMPERATURE V OUTP		J2: MOLEX MICRO FIT 430. MATES WITH 43025-100	PIN 4 - +3.3V -SENSE (RTN) PIN 5 - +5V -SENSE (RTN) PIN 6 - DPEN	ມ∩ບ⊷ III	J1: MOLEX MICRO FIT 43045- MATES WITH 43025-0600	[¥		יסר	A03 RE-ARRANGE INPUT		
	ES8 pvg ND.	P/N: CWA005	AEGIS POWER SYSTEMS MURPHY, NORTH CAROLINA	AEGIS POWER SYSTEMS, INC. PROPRIETARY INFORMATION. NO DISCLOSURE, EXERCIDUCTION, OR USE OF ANY PART HEREOF MAY BE MADE EXCEPT BY EXERCISE VRITTEN PERMISSION OF AEGIS POWER SYSTEMS, INC.	1.02 A60	EFF. 6.6W 4.0W DIS EFF. 41W 5.59W DIS EFF. 41W 5.59W DIS EFF. 109W 20.15W DIS.	4 5,764 V 5,76V S,76V	STUDS ARE 10-32 THREAD	STOR (BANK 1 DISABLE) OTOR (BANK 1 RTN) OTOR (BANK 2 DISABLE) OTOR (BANK 2 RTN)	45-0413 00	STATUS LED - CATHODE SVITCHED SUPPLIES ANODE US COLLECTOR TURE V OUTPUT	TTATUS LED - ANDDE SWITCHED SUPPLIES CATHDDE SUS EMITTER TURE VCC TURE GND	43045-1013 -1000	UN V		5-0613 00	CAU MAINIAINED. CHANGES SHALL BE INCORPORATED BY THE DESIGN ACTIVITY.	04715711	03/10/11	JT MODULES/STUDS 02/14/11 MRA TO 9.00" 02/21/11 MRA	REVISIONS DATE APPROVED	
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